Filename: PMP9018\_REVB\_BOM.xls Variant: 001

Generated: 7/22/2013 5:27:30 PM

## PMP9018 Rev B Bill Of Materials

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer
C1, C2	2	10uF	CAP ALUM 10UF 450V 20% RADIAL	10x20	450BXC10MEFCT810X20	Rubycon
C3	1	330uF	CAP ALUM 330UF 35V 20% RADIAL	10x20	UPJ1V331MPD1TD	Nichicon
C4	1	4.7uF	CAP, CERM, 4.7uF, 10V, +/-10%, X5R, 1206	1206	GRM31CR61A475KA01L	MuRata
C5	1	2200pF	CAP, CERM, 2200pF, 250V, +/-20%, KY, Radial D8x5mm	Radial D8x5mm	DE2E3KY222MA2BM01	MuRata
C6, C7, R10	3	DNP	Do Not Populate	0402	N/A	N/A
C8	1	1uF	CAP, CERM, 1uF, 50V, +/-10%, X7R, 0805	0805	GRM21BR71H105KA12L	MuRata
D1	1	600V	Diode, Switching-Bridge, 600V, 0.5A, MiniDIP	MiniDIP	RH06-T	Diodes Inc.
D2	1	120V	Diode, TVS, Uni, 120V, 400W, SMA	SMA	SMAJ120A	Littelfuse
D3	1	1.05V	Diode, Ultrafast, 600V, 1A, SMA	SMA	MURA160T3G	ON Semiconductor
D4	1	0.35V	DIODE SCHOTTKY 200V 4A DO214AB	SMC	SK4200L-TP	Micro Commercial Co
D5	1	1.25V	Diode, Ultrafast, 100V, 0.15A, SOD-123	SOD-123	1N4148W-7-F	Diodes Inc.
F1	1		Fuse, 0.5A, 250V, TH	8.35x7.7x4mm	RST 500	Bel Fuse
L1	1	100uH	Inductor, Drum Core, Ferrite, 100uH, 0.32A, 3.5 ohm, SMD	ME3220	ME3220-104KLB	Coilcraft
Q1	1	800V	MOSFET N-CH 800V 1.8A DPAK	DPAK	FQD2N80TM	Fairchild Semiconductor
R1, R3	2	2.67MEG	RES, 1%, 0.25W, 1206	1206	STD	STD
R2	1	100	RES, 1%, 0.25W, 1206	1206	STD	STD
R4	1	49.9k	RES, 1%, 0.063W, 0402	0402	STD	STD
R5	1	0	RES, 1%, 0.063W, 0402	0402	STD	STD
R6	1	82.5k	RES, 1%, 0.063W, 0402	0402	STD	STD
R7	1	1k	RES, 1%, 0.063W, 0402	0402	STD	STD
R8	1	23.7k	RES, 1%, 0.063W, 0402	0402	STD	STD
R9	1	1	RES, 1%, 0.125W, 0805	0805	STD	STD
T1	1	700uH	Transformer, 700uH, TH	760x580x675mil	RLTI-1092	Renco Electronics
TP1, TP2	2	White	Test Point, Multipurpose, White, TH	Testpoint	5012	Keystone
TP3	1	Red	Test Point, Multipurpose, Red, TH	Red Multipurpose Testpoint	5010	Keystone
TP4	1	Black	Test Point, Multipurpose, Black, TH		5011	Keystone
U1	1		Constant-Voltage, Constant-Current Controller With Primary-Side Regulation, DBV0006A	DBV0006A	UCC28700DBV	Texas Instruments

Notes:

Unless otherwise noted in the Alternate PartNumber and/or Alternate Manufacturer columns, all parts may be substituted with equivalents.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

## Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom **Amplifiers** amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID <u>www.ti-rfid.com</u>

OMAP Applications Processors <a href="www.ti.com/omap">www.ti.com/omap</a> TI E2E Community <a href="e2e.ti.com">e2e.ti.com</a>

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>